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HYBRID REDUNDANCY FOR ELECTRONIC **NETWORKS**

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H04N 21/61	(2011.01)
H04H 20/78	(2008.01)
H04L 12/413	(2006.01)
H04H 20/69	(2008.01)

(52) **U.S. Cl.**

CPC *H04N 21/6118* (2013.01); *H04H 20/78* (2013.01); *H04L 12/413* (2013.01); *H04H 20/69* (2013.01)

Field of Classification Search (58)

11/3055; G06F 11/32; G06F 11/325; G06F 2201/84; G06F 2201/815; G06F 2201/805; G06F 2201/86; H04L 41/24

See application file for complete search history.

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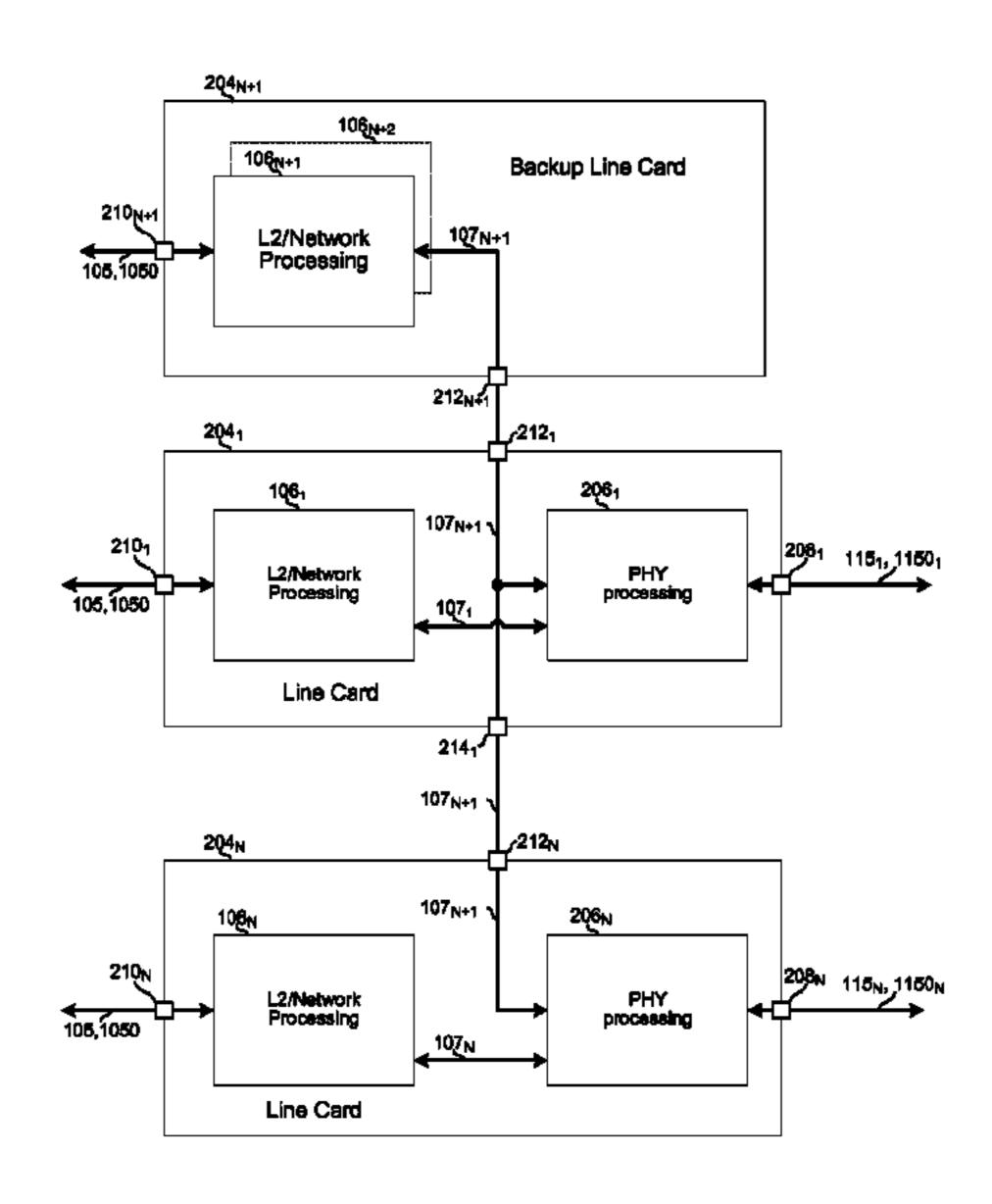
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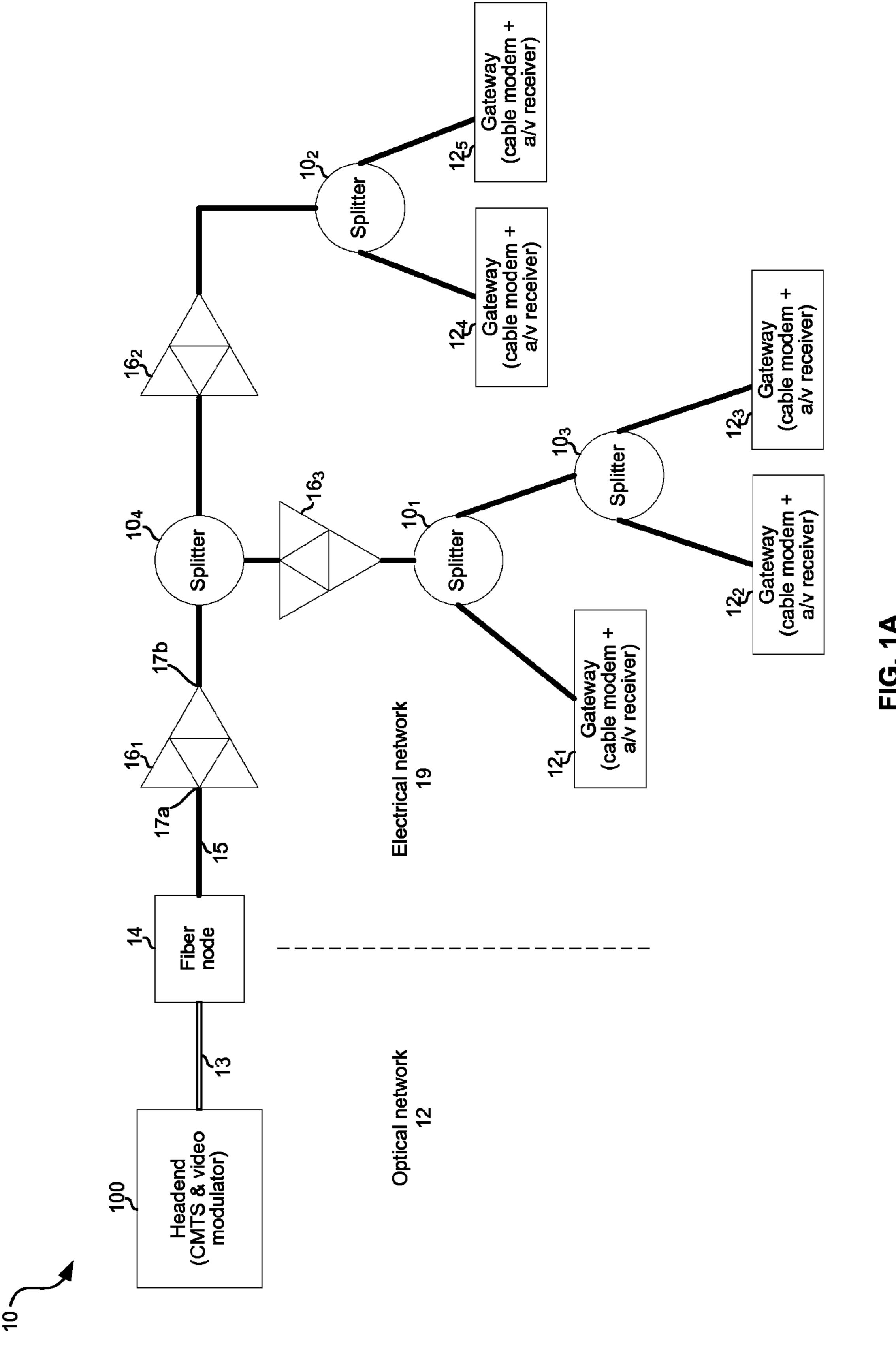
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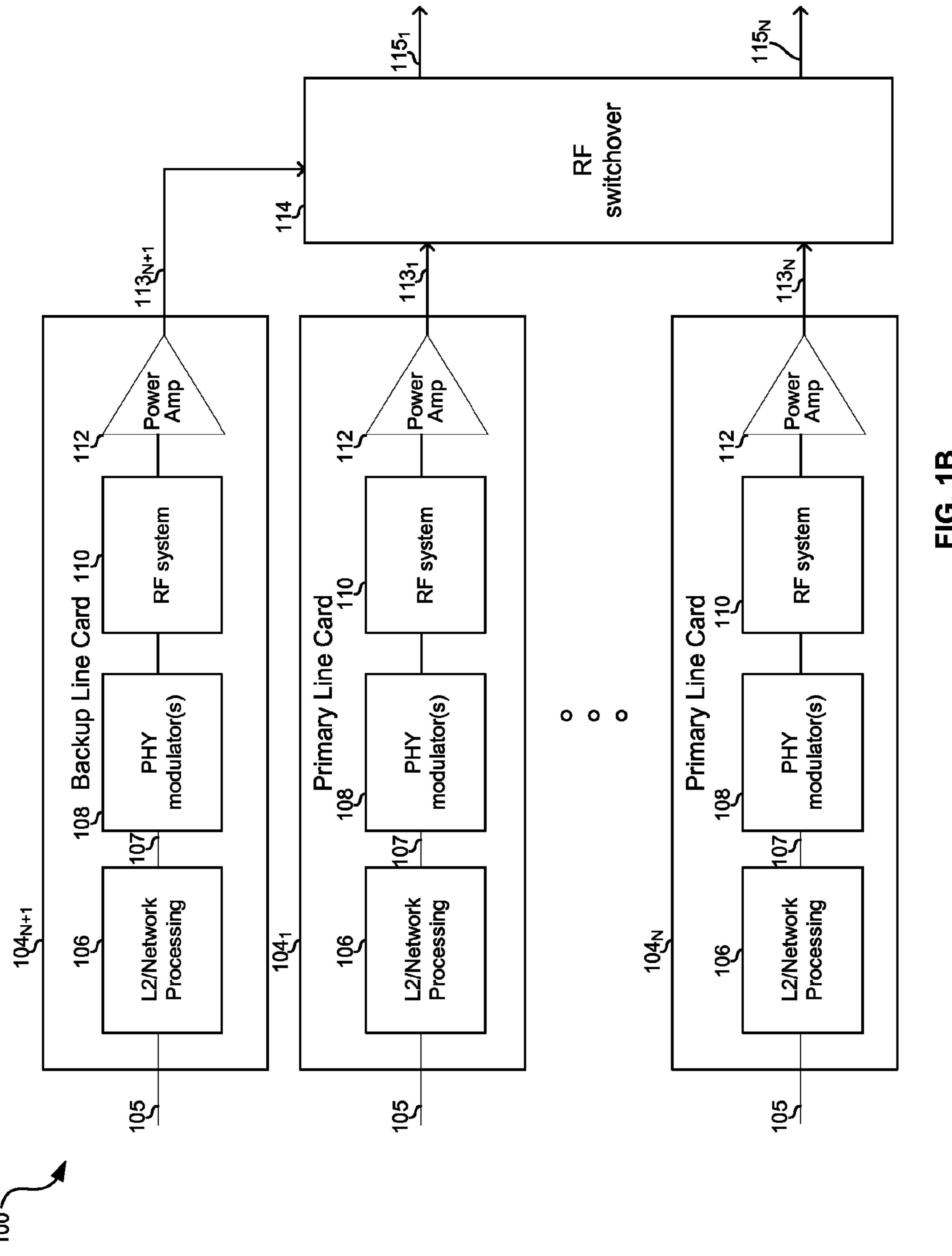
ABSTRACT (57)

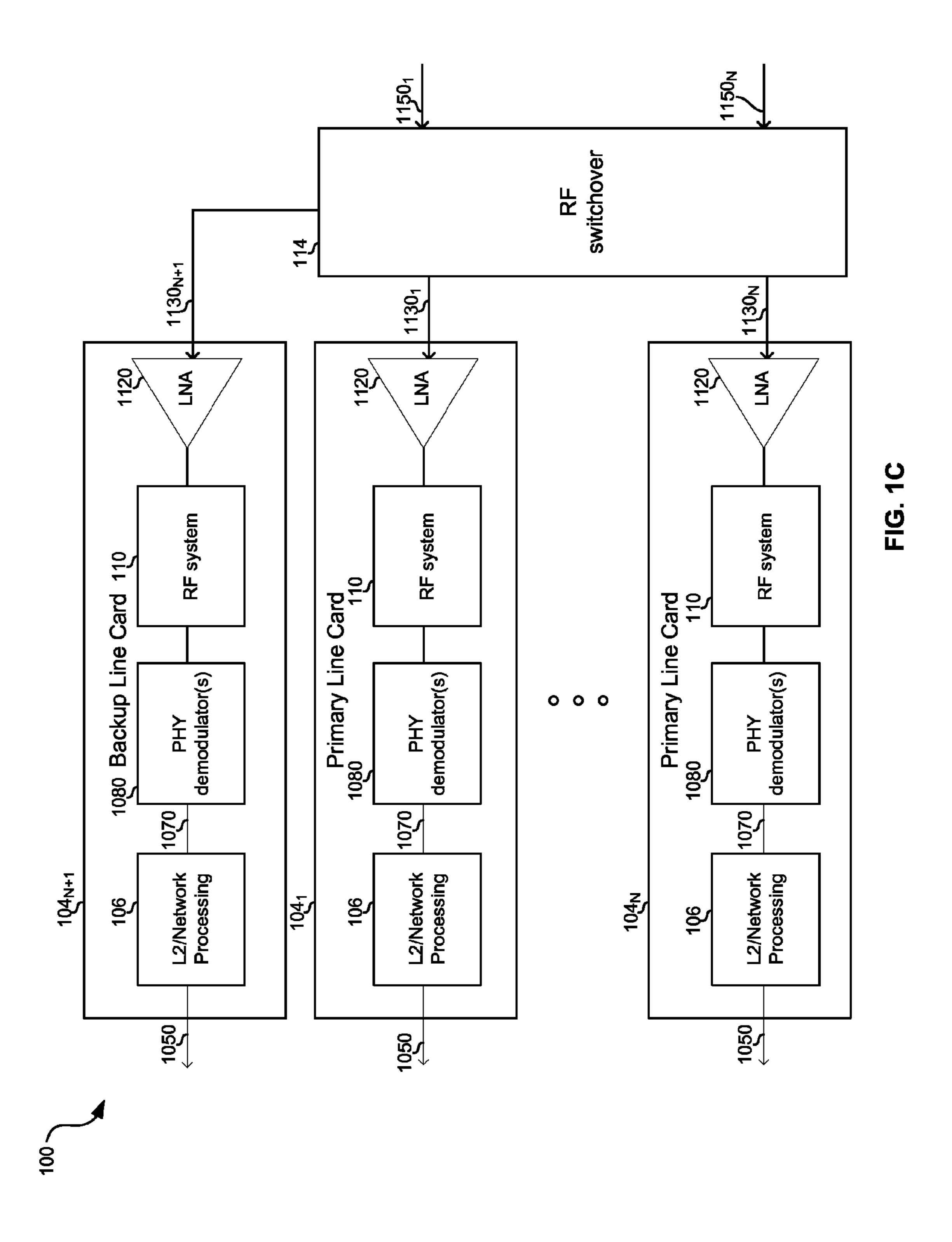
Aspects of a method and system for hybrid redundancy for electronic networks are provided. A first line card may comprise a first instance of a network layer circuit, a first instance of a physical layer circuit, and an interface to a data bus (e.g., an Ethernet bus) for communicating with a second line card. In response to detecting a failure of the first instance of the network layer circuit, the first instance of the physical layer circuit may switch from processing of a signal received via the first instance of the network layer circuit to processing of a signal received via the interface. The system may comprise a second line card. The second line card may comprise a second instance of the network layer circuit. The second instance of the network layer circuit may be coupled to the data bus.

16 Claims, 7 Drawing Sheets









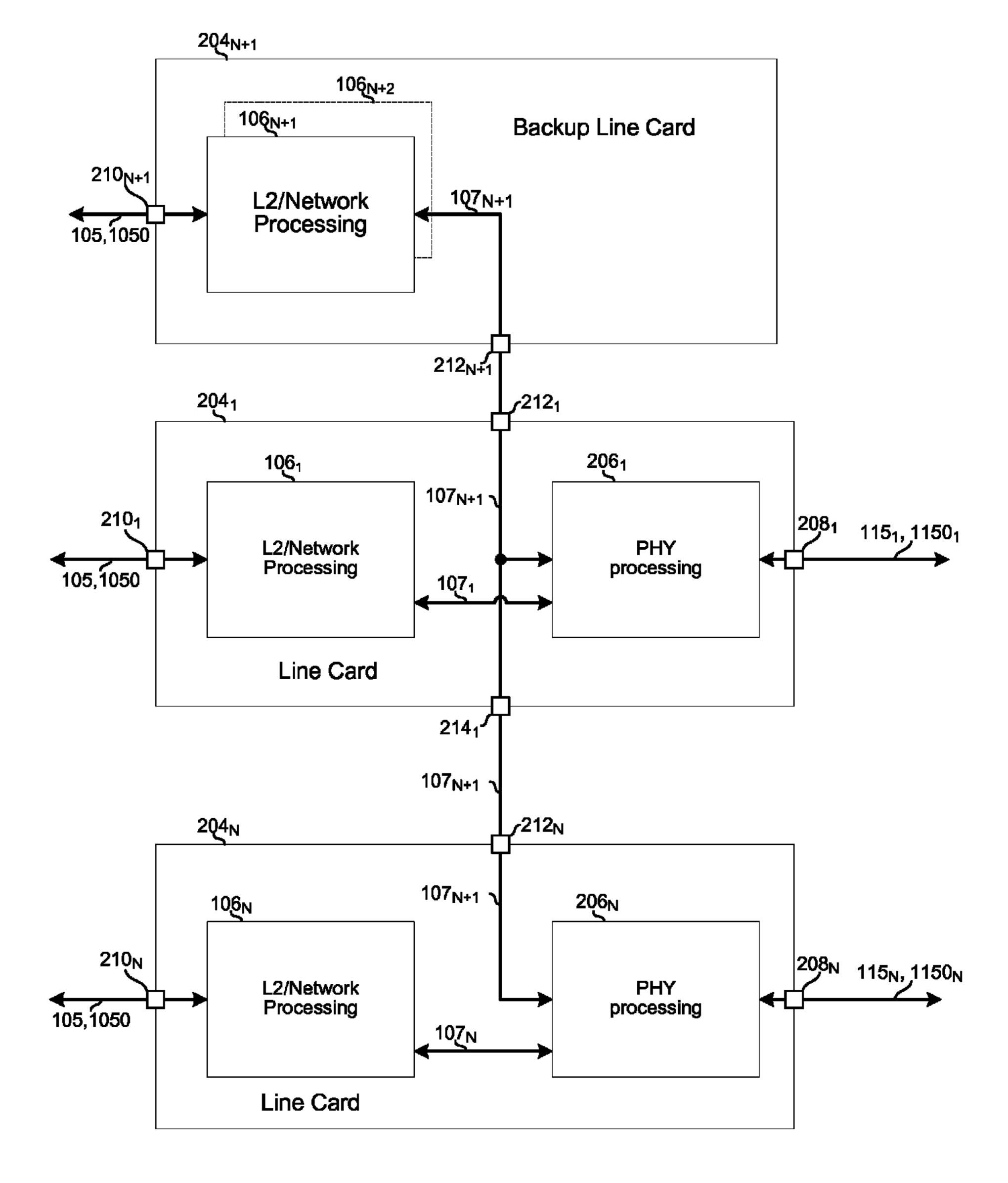
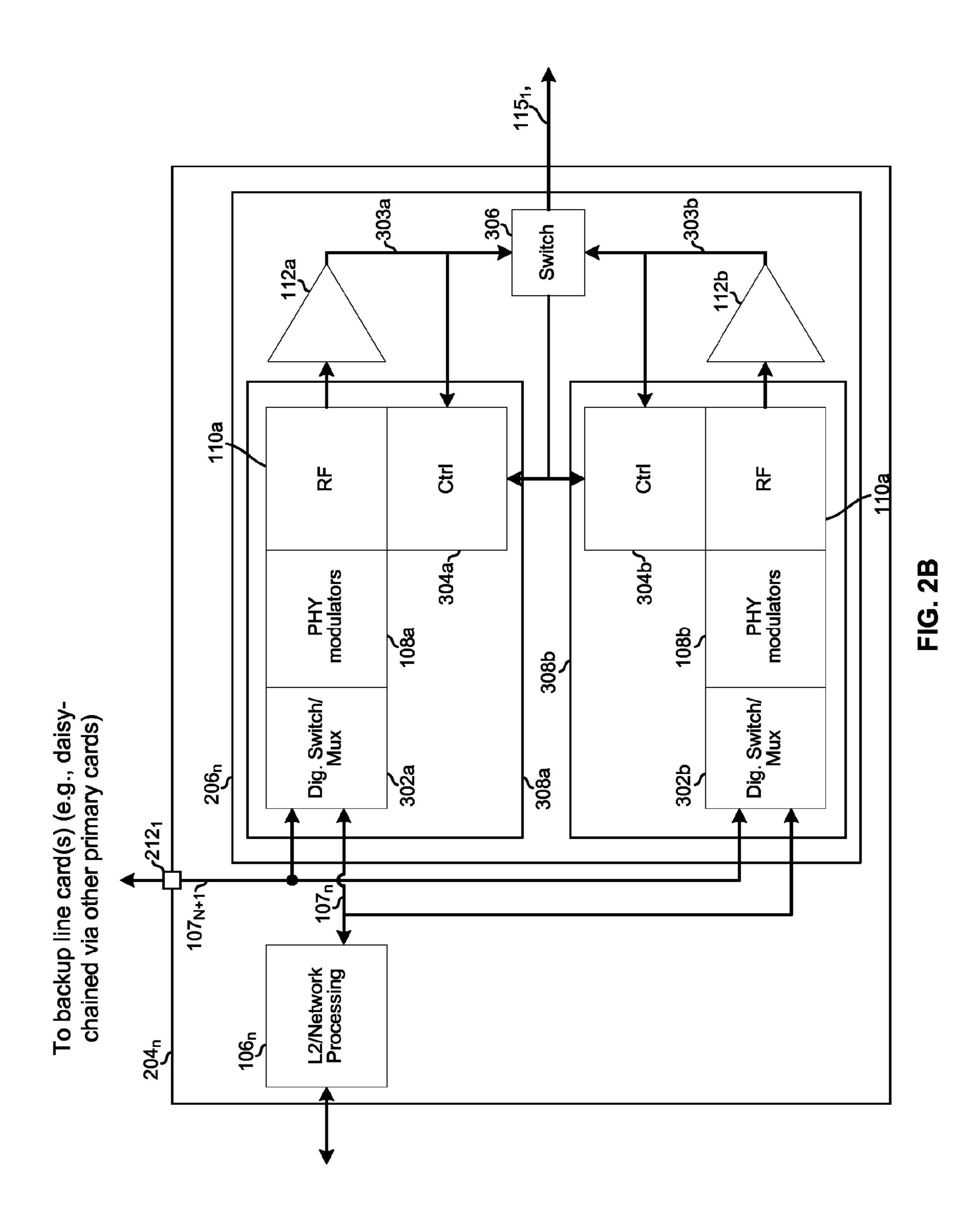


FIG. 2A



11501 Switch 1120a 110a R F PHY demodulators 304a 305a 305b 1080a 1080b 308b Dig. Switch/ Mux Dig. Switch/ Mux To backup line card(s) (e.g., daisy-chained via other primary cards) 206_n 302b 302a 308a r212₁ 107_{N+1} 107_n L2/Network Processing 106_n 204_n

FIG. 20

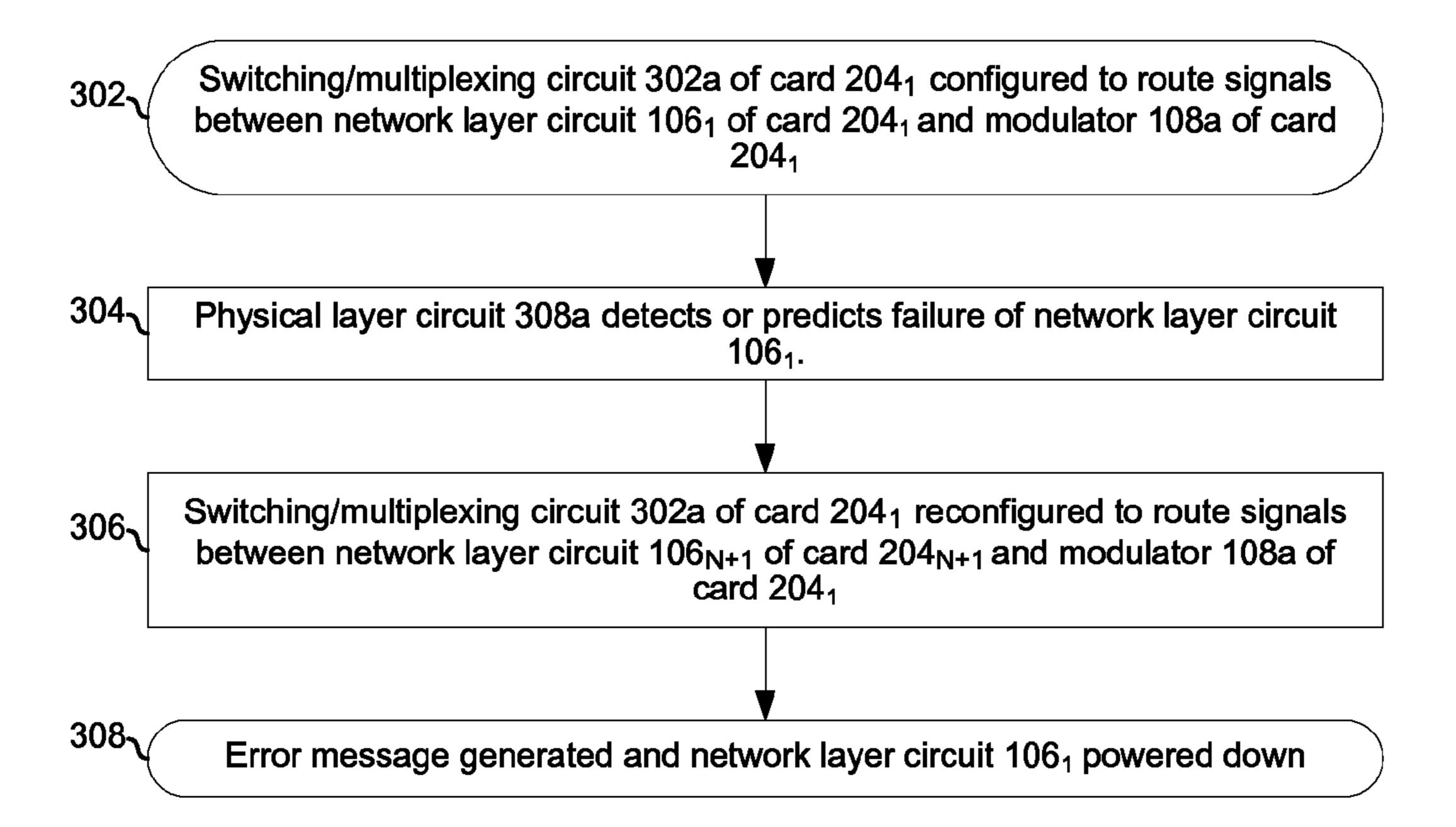


FIG. 3

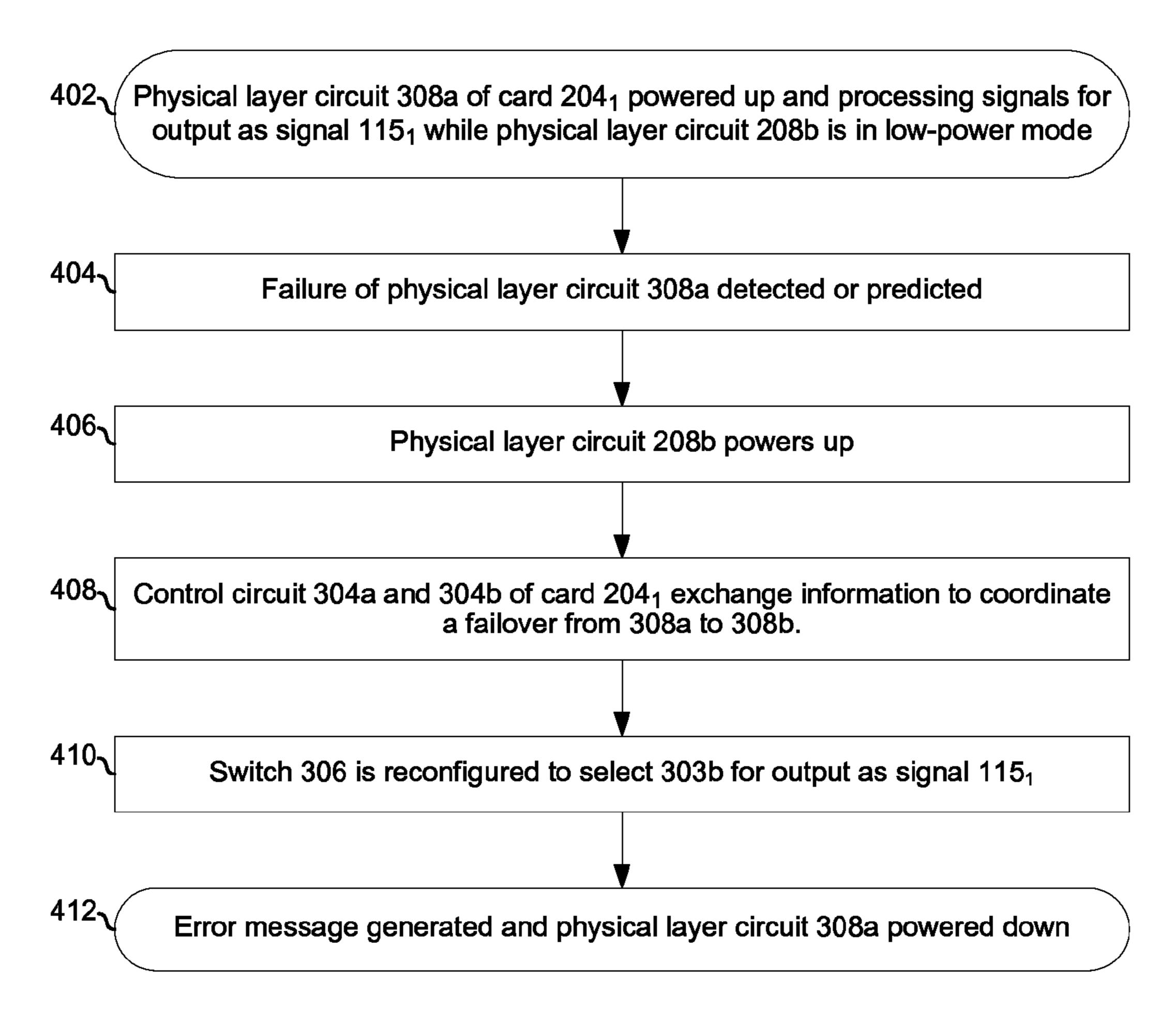


FIG. 4

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HYBRID REDUNDANCY FOR ELECTRONIC NETWORKS

PRIORITY CLAIM

This application claims priority to the following application(s), each of which is hereby incorporated herein by reference:

U.S. provisional patent application 61/767,914 titled "Hybrid Redundancy for Electronic Networks" filed on Feb. 22, 2013.

TECHNICAL FIELD

Certain embodiments of the invention relate to electronic networking. More specifically, certain embodiments of the invention relate to methods and systems for hybrid redundancy.

BACKGROUND

Existing methods and systems for providing network access are inadequate for meeting the needs of current, and next-generation electronic networks. Further limitations and disadvantages of conventional and traditional approaches will become apparent to one of skill in the art, through comparison of such systems with some aspects of the present invention as set forth in the remainder of the present application with reference to the drawings.

BRIEF SUMMARY OF THE INVENTION

A system and/or method is provided for hybrid redundancy for electronic networks, substantially as shown in and/or described in connection with at least one of the figures, as set forth more completely in the claims.

These and other advantages, aspects and novel features of the present invention, as well as details of an illustrated embodiment thereof, will be more fully understood from the following description and drawings.

BRIEF DESCRIPTION OF SEVERAL VIEWS OF THE DRAWINGS

FIG. 1A is a diagram depicting an example hybrid fiber- 45 coaxial (HFC) network.

FIG. 1B is a diagram illustrating transmit components of a first system with redundancy.

FIG. 1C is a diagram illustrating receive components of the first system of FIG. 1B.

FIG. 2A is a diagram illustrating a second system with redundancy.

FIGS. 2B and 2C illustrate an example physical layer module for use in the system of FIG. 2A.

FIG. 3 is a flowchart illustrating an example process for 55 recovering from failure of an L2 processing circuit.

FIG. 4 is a flowchart illustrating an example process for recovering from failure of a physical layer circuit.

DETAILED DESCRIPTION OF THE INVENTION

As utilized herein the terms "circuits" and "circuitry" refer to physical electronic components (i.e. hardware) and any software and/or firmware ("code") which may configure the hardware, be executed by the hardware, and or otherwise be 65 associated with the hardware. As used herein, for example, a particular processor and memory may comprise a first "cir-

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cuit" when executing a first one or more lines of code and may comprise a second "circuit" when executing a second one or more lines of code. As utilized herein, "and/or" means any one or more of the items in the list joined by "and/or". As an example, "x and/or y" means any element of the three-element set $\{(x), (y), (x, y)\}$. As another example, "x, y, and/or z" means any element of the seven-element set $\{(x), (y), (z), (x, y), (y, y), ($ y), (x, z), (y, z), (x, y, z)}. As utilized herein, the term "exemplary" means serving as a non-limiting example, instance, or 10 illustration. As utilized herein, the terms "e.g.," and "for example" set off lists of one or more non-limiting examples, instances, or illustrations. As utilized herein, circuitry is "operable" to perform a function whenever the circuitry comprises the necessary hardware and code (if any is necessary) to perform the function, regardless of whether performance of the function is disabled, or not enabled, by some user-configurable setting.

FIG. 1A is a diagram depicting an example hybrid fiber-coaxial (HFC) network. The example HFC network 10 comprises a headend 100, a fiber node 14, amplifiers 16₁-16₃, splitters 10₁-10₄, and gateways 12₁-12₅.

The headend 100 comprises a cable modem termination system (CMTS) for handling data over coaxial service interface specification (DOCSIS) traffic to and from the cable modems of gateways 12₁-12₅ and one or more modulators (e.g., one or more "edge QAMs") for handling downstream multimedia traffic to the audio/video receivers of the gateways 12₁-12₅. Details of an example headend in accordance with various implementations of this disclosure are described below with reference to FIGS. 1B-4.

The fiber node 14 may provide an interface between the optical network 12 and the electrical network 19.

Each of the amplifiers 16_1 - 16_3 may comprise a bidirectional amplifier which may amplify downstream signals and upstream signals, where downstream signals are input via upstream interface 17a and output via downstream interface 17b, and upstream signals are input via downstream interface 17b and output via upstream interface 17a. The amplifier 16_1 , which amplifies signals along the main coaxial "trunk," may be referred to as a "trunk amplifier." The amplifiers 16_2 and 16_3 , which amplify signals along "branches" split off from the trunk, may be referred to as "branch" or "distribution" amplifiers.

Each of the splitters 10_1 - 10_4 comprises circuitry operable to output signals incident on each of its interfaces onto each of its other interfaces. Each of the splitters 10_1 - 10_4 may be a passive or active device which supports bidirectional transfer of signals.

Each of the gateways 12₁-12₅ may comprise cable modem circuitry operable to communicate with, and be managed by, the headend 100 in accordance with one or more standards (e.g., DOCSIS). Each of the gateways 12₁-12₅ may comprise one or more audio/video receivers operable to receive multimedia content (e.g., in the form of one or more MPEG streams) transmitted by the headend 100 in accordance with one or more standards used for cable television. Each of the gateways 12₁-12₅ may reside at the premises of a cable/ DOCSIS subscriber.

FIG. 1B is a diagram illustrating transmit components of a first system with redundancy. Depicted is an example system 100 comprising a plurality of primary line cards 104₁-104_N, a backup line card 104_{N+1}, and an RF switchover circuit 114. Each of the line cards comprises a L2 processing circuit 106, a physical layer modulator circuit 108, an RF circuit 110, and a power amplifier circuit (PA) 112. The system 100 may be, for example, part of a network server, switch, router, cable modem termination system (CMTS), fiber node (i.e., device

of HFC network which converts interfaces one or more optical links from the headend with one or more coaxial cable trunks) and/or other networking device. In an example implementation, the system 100 resides at a headend or fiber node.

Each line card 104_n ($1 \le n \le N$) may receive an input signal 5 105. In an example implementation, the signal 105 may be, for example, from a cable service provider core network where the system 100 is at the headend. In an example implementation, the signal 105 may be, for example, from a headend where the system 100 is in a fiber node. The signal 105 may be processed by L2 processing circuit 106 of each card 104_1-104_{N+1} (e.g., packetization, logical link layer control (LLC) functions, media access control (MAC) functions, and/ or higher OSI layer functions may be performed) to generate a corresponding signal 107. The signal 107 may be processed 15 by corresponding modulator circuit 108, RF circuit 110, and PA 112 (e.g., interleaving, symbol mapping, forward error correction (FEC) encoding, digital to analog conversion, upconversion to RF, amplification, and/or other physical layer functions may be performed according to a determined 20 standard such as DOSCIS) to generate a corresponding one of signals 113_1 - 113_{N+1} . The RF switchover circuit 114 maps N of the signals 113_1-113_{N+1} to the signals 115_1-115_N and is operable to perform failover to swap out a failed line card with a functioning line card. For example, if line card 104_{χ} (where 25 1≤X≤N) fails, then RF switchover circuit 114 may detect the failure and reconfigure itself to use line card 104_{N+1} instead of failed line card 104_X . That is, the RF switchover circuit 114may decouple signal 113_X from signal 115_X and instead couple signal 113_{N+1} to signal 115_{X} . The signals 115_{1} - 115_{N} 30 may be conveyed to, for example, laser modulators in a headend, to coaxial cables in a fiber node, or to antennas in a wireless system.

FIG. 1C is a diagram illustrating receive components of the ponents already discussed with reference to FIG. 1B (some of which are not shown in FIG. 1C for clarity of illustration) each line card 104_n ($1 \le n \le N$) comprises a low noise amplifier **1120** and demodulator(s) **1080**. Each LNA **1120**_n (1≤n≤N+1) may amplify the signal 1130_n ($1 \le n \le N+1$). Each demodulator 40 1080_n (1≤n≤N+1) may demodulate the upstream signal output by the respective RF system 110_n .

The RF switchover circuit 114 maps the signals 1150_1 - 1150_{N+1} to N of the signals 1130_1 - 1130_{N+1} and is operable to perform failover to swap out a failed line card with a func- 45 tioning line card. For example, if line card 104_X (where 1≤X≤N) fails, then RF switchover circuit 114 may detect the failure and reconfigure itself to use line card 104_{N+1} instead of failed line card 104_x . That is, the RF switchover circuit 114may decouple signal 1150_X from signal 1130_X and instead 50 couple signal 1150_X to signal 1130_{N+1} . The upstream signals 1150 may coexist on the same physical medium, or use a different physical medium, as the downstream signals 115 shown in FIG. 1B. Similarly the signals 150 may coexist on the same physical medium, or use a separate physical 55 medium, as the signals 105 shown in FIG. 1B.

FIG. 2A is a diagram illustrating a second system with redundancy. The example system 200 comprises line cards 204_1 - 204_N and a line card 204_{N+1} . The system 200 may be, for example, part of a network server, switch, router, cable 60 modem termination system (CMTS), fiber node, and/or other networking device. In an example implementation, the system 200 resides at a cable headend.

Each line card 204_n ($1 \le n \le N$) comprises an interface 210_n for signal(s) 105 and/or 1050, a L2 processing circuit 106, 65 (each L2 processing circuit 106, being an instance of L2 processing circuit 106 described above, for example), a

physical layer circuit 206_n (an example implementation of which is described below with reference to FIGS. 2B and 2C), an interface 208_n for signal(s) 115_n and/or 1150_n , and one or more interfaces 212 and/or 214 for connecting to backup line card 204_{N+1} (i.e., for exchange of signals 107_{N+1}). In an example implementation, each of signals 107_1 - 107_N and 107_{N+1} may be conveyed via a gigabit or 10-gigabit Ethernet link.

The line card 204_{N+1} comprises an interface 210_{N+1} for signal(s) 105 and/or 1050, a L2 processing circuit 106_{N+1} (which is an instance of L2 processing circuit **106** described above, for example), and an interface 212_{N+1} for coupling to one or more physical layer circuits 206_n (i.e., for exchange of signals 107_{N+1}). In an example implementation, M (an integer) additional L2 processing circuits 106_{N+2} - 106_{N+1+M} (each being an instance of L2 processing circuit 106 described above, for example) may be implemented on the line card 204_{N+1} . Circuits 106_{N+1} - 106_{N+1+M} on the line card 204_{N+1} enable accommodating failure of M+1 of the L2 processing circuits 106_1 - 106_N . That is, up to M+1 of the L2 processing circuits 106_1-106_N may fail without the recipient(s) of signals 115_1 - 115_N experiencing any loss of service (except perhaps a temporary disruption while the failover occurs). Where the card 204_{N+1} is of the same dimensions/form factor as each of the cards 204_1 - 204_N , placement of M+1 instances of circuit 106 on the line card 204_{N+1} may be possible due to fewer (or no) instances of physical layer circuit 206 on the card 204_{N+1} .

In the absence of failure of L2 processing circuit 106_n $(1 \le n \le N)$ (or some other upstream component affecting line card 204, such as a splitter providing the signal 105 to card 204_n), physical layer circuit 206_n may process the downstream portion of signal 107, to generate signal 115, and/or process the signal 1150_n to generate corresponding upstream first system of FIG. 1B. In this example, in addition to com- 35 portion of signal 107_n. In the presence of a failure of 106_n (1≤n≤N), or some other upstream component affecting line card 204, physical layer circuit 206, may process the downstream portion of signal 107_{N+1} to generate signal 115_n and/or process signal 1150, to generate a corresponding upstream portion of signal 107_{N+1} . An example implementation of an instance of the physical layer circuit 206 is described below with reference to FIGS. 2B and 2C.

FIGS. 2B and 2C are diagrams illustrating an example physical layer circuit for use in the system of FIG. 2A. For clarity of illustration, the diagram is split into two figures with transmit components shown in FIG. 2B and receive components shown in FIG. 2C. The example line card 204, shown in FIGS. 2B and 2C comprises a L2 processing circuit 106_n (described above), physical layer circuit 206, PAs 112a and 112b, LNAs 1120a and 1120b, and switch 306. Each of 108a and 108b may be an instance of PA 112 of FIG. 1B, for example. The physical layer circuit 206, comprises primary circuit 308a and backup circuit 308b. Primary circuit 308a comprises digital switching/multiplexing circuit 302a, PHY modulator circuit 108a, PHY demodulator circuit 1080a, RF circuit 110a, and control circuit 304a. Similarly, backup circuit 308b comprises digital switching/multiplexing circuit 302b, PHY modulator circuit 108b, PHY demodulator circuit 1080b, RF circuit 110b, and control circuit 304b. Each of 108a and 108b may be an instance of modulator circuit 108 of FIG. 1B, for example. Each of 1080a and 1080b may be an instance of modulator circuit **1080** of FIG. **1**C, for example. Each of 110a and 110b may be an instance of RF circuit 110 of FIG. 1B, for example. In an example implementation, primary circuit 308a and LNA 1120a is on a first semiconductor die, backup circuit 308b and LNA 1120b is on a second semiconductor die, PA 112a is on a third semiconductor die,

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PA 112b is on a fourth semiconductor die, and switch 306 is on a fifth semiconductor die. In other example implementations, any two or more of 308a, 308b, 112a, 112b, and 306 may be integrated on a shared semiconductor die.

The switching/multiplexing circuit 302a may be operable 5 to select which of signals 107_n and 107_{N+1} are coupled to modulator circuit 108a and demodulator circuit 1080a. Which of the signals 107_n and 107_{N+1} is selected may be based on a control signal from control circuit 304a that indicates whether L2 processing circuit 106, of the card 204, has failed. If 106, has failed, the switching/multiplexing circuit 302a may be configured to select signal 107_{N+1} . In an example implementation, the switching/multiplexing circuit 302a may operate as a layer 2 (or higher layer) switch (e.g., an $_{15}$ Ethernet switch) for switching traffic among L2 processing circuit 106_n , L2 processing circuit 106_{N+1} , modulator circuit 108a, and demodulator circuit 1080a. State information, failure notifications, and/or other traffic may be exchanged among L2 processing circuits 106_1 - 106_{N+1} . Monitoring/sens- 20 ing that the control circuit 304a may perform to detect a failure may include, for example, monitoring/sensing voltage, current, power levels, and/or other characteristics of the signal 303a; monitoring/sensing current drawn by one or more of the switching/multiplexing circuit 302a, modulator 25 circuit 108a, demodulator circuit 1080a, RF circuit 110a, PA 112a, and LNA 1120a, and/or monitoring a temperature of one or more of the switching/multiplexing circuit 302a, modulator circuit 108a, demodulator circuit 1080a, RF circuit **110***a*, PA **112***a*, and LNA **1120***a*. In an example imple- 30 mentation, based on the sensing/monitoring, the control circuit 304a may be operable to predict a failure rather than waiting for a failure.

The switching/multiplexing circuit 302b may be operable to select which of signals 107_n and 107_{N+1} are coupled to 35 modulator circuit 108b and demodulator circuit 1080b. Which signal is selected may be based on a control signal from control circuit 304b that indicates whether L2 processing circuit 106, of the card 204, has failed. If 106, has failed, the switching/multiplexing circuit 302b may select signal 40 107_{N+1} . In an example implementation, the switching/multiplexing circuit 302b may operate as a layer 2 (or higher layer) switch (e.g., an Ethernet switch) for switching traffic among L2 processing circuit 106_n , L2 processing circuit 106_{N+1} , modulator circuit 108b, and demodulator circuit 1080b. State 45 information, failure notifications, and/or other traffic may be exchanged among L2 processing circuits 106_1-106_{N+1} . Monitoring/sensing that the switching/multiplexing circuit 302b may perform to detect a failure may include, for example, monitoring/sensing voltage, current, power levels, 50 and/or other characteristics of the signal 303b; monitoring/ sensing current drawn by one or more of the switching/multiplexing circuit 302b, modulator circuit 108b, demodulator circuit **1080**b, RF circuit **110**b, PA **112**b, and LNA **1120**b, monitoring a temperature of one or more of the switching/ 55 multiplexing circuit 302b, modulator circuit 108b, demodulator circuit 1080b, RF circuit 110b, PA 112b, and LNA **1120***b*. In an example implementation, based on the sensing/ monitoring, the control circuit 304b may be operable to predict a failure rather than waiting for a failure.

Processing of the output of switching/multiplexing circuit 302a by the modulator circuit 108a, RF circuit 110a, and PA 112a may be substantially similar to processing by modulator circuit 108, RF circuit 110, and PA 112 described above with reference to FIG. 1B. Similarly, processing of the output of 65 switching/multiplexing circuit 302b by the modulator circuit 108b, RF circuit 110b, and PA 112b may be substantially

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similar to processing by modulator circuit 108, RF circuit 110, and PA 112 described above with reference to FIG. 1B.

Processing of upstream signals by the demodulator 1080a and LNA 1120a may be substantially similar to processing by demodulator circuit 1080 and LNA 1120 described above with reference to FIG. 1C. Similarly, Processing of upstream signals by the demodulator 1080b and LNA 1120b may be substantially similar to processing by demodulator circuit 1080 and LNA 1120 described above with reference to FIG. 1C.

The control circuit 304a may monitor the signals 303a and/or 305a to detect problems with the circuit 308a. Similarly, the control circuit 304b may monitor the signals 303a and/or 305a to detect problems with the circuit 308a. If a problem is detected, the control circuits 304a and 304b may, through a failover negotiation algorithm, reconfigure the switch 306 to select the non-failed one of the circuits 308a and 308b and/or may reconfigure or more of 302a, 302b, 108a, 108b, 110a, 110b, 112a, and 112b.

In an example implementation, during normal operation, the circuit 308a and PA 112a may be active and the signal 303a may be selected for use by the switch 306. During such normal operation, the circuit 308b may be in a low-power state (e.g., one or more of switching/multiplexing circuit 302b, modulator circuit 108b, demodulator circuit 1080b, RF circuit 110b, and LNA 1120b may be powered down) and/or the PA 112b may be in a low power state. In this manner, although there are almost twice as many PHY circuits in the system of FIGS. 2A-2C, as compared to the system of FIG. 1B, power consumption in the line cards may increase only slightly due to only half operating at any given time, and a net power savings may be achieved due to elimination of the RF switchover circuit 114.

Upon a failure of switching/multiplexing circuit 302a, modulator circuit 108a, demodulator circuit 1080a, RF circuit 110a, LNA 1120a, and/or PA 112a, the control circuit 304a may detect the failure and coordinate, with control circuit 304b, a transition (e.g., by reconfiguring one or more of 302a, 302b, 108a, 108b, 1080a, 1080b, 110a, 110b, 112a, 112b, 1120a, 1120b, and 306) such that the circuit 308bpowers up, the switch 306 selects the signal 303b, and the circuit(s) 308a and/or PA 112a are put in a low-power state. Additionally, an error message may be generated and transmitted. In an example implementation, during normal operation the backup circuit 308b may be in a low-power mode that enables very fast switchover from circuit 308a to 308b in the event of a failure. To this end, the control circuits 304a and **304***b* may occasionally and/or periodically exchange state information for the switching/multiplexing circuit 302a, modulator circuit 108a, demodulator circuit 1080a, RF circuit 110a, and/or PA 112a which may be used by switching/ multiplexing circuit 302b, modulator circuit 108b, demodulator circuit 1080b, RF circuit 110b, and/or PA 112b for quickly coming on-line. Example state information includes contents of PHY modulators, timing/synchronization information, power levels, gain settings, measured channel characteristics, filter tap coefficients, and/or the like. In an 60 example implementation, although the system 200 has almost twice the number of PAs as the system 100, only one of the amplifiers operating at a time may permit the two amplifiers to be placed next to each other and share a heat sink.

In an example implementation, the control circuits 304a and 304b may perform sensing/monitoring and report the results of such sensing/monitoring to one or more of the L2 processing circuits 106_1-106_{N+1} which may then perform

failure determination and failover coordination, and may trigger reconfiguration of components 308a and 308b, as necessary.

One advantage of the system of FIGS. 2A-2C over the system of FIGS. 1B-1C may be the elimination of the RF 5 switchover circuit **114**. This is an advantage because the RF switchover circuit 114 often takes up an entire server rack and comprises expensive RF components. Thus, the system of FIGS. 2A-2C may provide cost and space savings. Relatedly, another advantage of the system of FIGS. 2A-2C may be that 10 all RF processing is confined to the line cards. This may improve emissions, interference, and/or other issues. Furthermore, the interconnection of line cards using standardized digital communications (e.g., Ethernet) may be simpler, switchover circuit 114.

One advantage of the system of FIGS. 2A-2C over the system of FIGS. 1B-1C may be that, in the system of FIGS. 2A-2C, multiple PHY failures can be tolerated, whereas in the system of FIGS. 1B-1C, there is only one redundant PHY.

FIG. 3 is a flowchart illustrating an example process for recovering from failure of an L2 processing circuit. The process begins with block 302 in which switching/multiplexing circuit 302a of card 204₁ is configured to route signals between network layer circuit 106, of card 204, and modu- 25 lator 108a/demodulator 1080a of card 204₁. In block 304, physical layer circuit 308a of card 204₁ detects or predicts failure of network layer circuit 106₁. In block 306, switching/ multiplexing circuit 302a of card 204_1 is reconfigured to route signals between network layer circuit 106_{N+1} of card 204_{N+1} and modulator 108a/demodulator 1080a of card 204₁. In block 308, an error message is generated (e.g., to alert a network administrator of the failure) and network layer circuit 106_1 is powered down.

FIG. 4 is a flowchart illustrating an example process for 35 cesses as described herein. recovering from failure of a physical layer circuit. The process begins with block 402 in which physical layer circuit 308a of card 204₁ is powered up and is processing received signal 1150₁ and/or outputting signal 115₁ via switch 306, while physical layer circuit 208b is in a low-power mode. In 40 block 404, a failure of physical layer circuit 308a is detected or predicted (e.g., based on monitoring of signal 303a). In block 406, the physical layer circuit 208b is powered up in response to the detection or prediction of failure in block 404. In block 408, control circuits 304a and 304b of card 204_1 45 exchange information to coordinate a failover. In block 410, switch 306 is reconfigured to switch from a configuration in which signal(s) 115₁ and/or 1150₁ and signal 303a coupled to a configuration in which signal(s) 115₁ and/or 1150₁ and signal 303b are coupled. In block 412, an error message is 50 generated (e.g., to alert a network administrator of the failure) and physical layer circuit 308a is powered down.

In an example implementation of this disclosure, a first line card (e.g., 104₁ or 204₁) may comprise a first instance of a network layer circuit (e.g., 106_1), a first instance of a physical 55 layer circuit (e.g., 308a), and an interface (e.g., 212_1) to a data bus (e.g., an Ethernet bus) for communicating with a second line card (e.g., 204_{N+1}). In response to detecting a failure of the first instance of the network layer circuit, the first instance of the physical layer circuit may switch from processing of a 60 signal (e.g., 107_n) received via the first instance of the network layer circuit to processing of a signal (e.g., 107_{n+1}) received via the interface. The system may comprise a second line card. The second line card may comprises a second instance of the network layer circuit (e.g., 106_{N+1}). The sec- 65 ond instance of the network layer circuit may be coupled to the data bus (e.g., via interface 212_{N+1}). The second line card

may comprise a third instance of the network layer circuit (e.g., 106_{N+2}). An output of the third instance of the network layer circuit may be coupled to the data bus (e.g., via interface 212_{N+1}). The second line card may not comprise any instances of any physical layer circuit (i.e., may only have circuitry that performs OSI layer 2 and/or higher layer functions). The second line card may have the same form factor as the first line card (e.g., may plug into the same type of socket that the first line card plugs into).

The first line card may comprise a second instance of the physical layer circuit (e.g., 308b). In response to detecting a failure of the first instance of the network layer circuit, the second instance of the physical layer circuit may switch from processing of a signal received via the first instance of the cheaper, and more flexible that performing failover in the RF 15 network layer circuit (e.g., 107_n) to processing of a signal received via the interface (e.g., 107_{n+1}). Upon a detection of a failure of the first instance of the physical layer circuit, the first instance of the physical layer circuit may communicate with the second instance of the physical layer circuit to effect 20 a failover from the first instance of the physical layer circuit to the second instance of the physical layer circuit. The first instance of the second circuit may be coupled to a first power amplifier (e.g., 112a). The second instance of the second circuit may be coupled to a second power amplifier (e.g., 112b). The first instance of the physical layer circuit may be operable to detect the failure by monitoring an output of the first power amplifier.

> Other embodiments of the invention may provide a nontransitory computer readable medium and/or storage medium, and/or a non-transitory machine readable medium and/or storage medium, having stored thereon, a machine code and/or a computer program having at least one code section executable by a machine and/or a computer, thereby causing the machine and/or computer to perform the pro-

> Accordingly, the present invention may be realized in hardware, software, or a combination of hardware and software. The present invention may be realized in a centralized fashion in at least one computing system, or in a distributed fashion where different elements are spread across several interconnected computing systems. Any kind of computing system or other apparatus adapted for carrying out the methods described herein is suited. A typical combination of hardware and software may be a general-purpose computing system with a program or other code that, when being loaded and executed, controls the computing system such that it carries out the methods described herein. Another typical implementation may comprise an application specific integrated circuit or chip.

> The present invention may also be embedded in a computer program product, which comprises all the features enabling the implementation of the methods described herein, and which when loaded in a computer system is able to carry out these methods. Computer program in the present context means any expression, in any language, code or notation, of a set of instructions intended to cause a system having an information processing capability to perform a particular function either directly or after either or both of the following: a) conversion to another language, code or notation; b) reproduction in a different material form.

> While the present invention has been described with reference to certain embodiments, it will be understood by those skilled in the art that various changes may be made and equivalents may be substituted without departing from the scope of the present invention. In addition, many modifications may be made to adapt a particular situation or material to the teachings of the present invention without departing

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from its scope. Therefore, it is intended that the present invention not be limited to the particular embodiment disclosed, but that the present invention will include all embodiments falling within the scope of the appended claims.

What is claimed is:

- 1. A system comprising:
- a first line card comprising a first instance of a network layer circuit, a first instance of a physical layer circuit, and an interface to a data bus for communication with a second line card, wherein:
 - said first instance of said physical layer circuit is operable to switch, in response to detection of a failure of said first instance of said network layer circuit, from processing of a signal received via said first instance of said network layer circuit to processing of a signal 15 received via said interface;
 - said second line card comprises a second instance of said network layer circuit; and
 - said second instance of said network layer circuit is coupled to said data bus;
 - said second line card comprises no instances of any physical layer circuit.
- 2. The system of claim 1, wherein

Said second line card comprises a third instance of said network layer circuit; and

Said third instance of said network layer circuit is coupled to said data bus.

- 3. The system of claim 1, wherein said second line card has a same form factor as said first line card.
 - 4. The system of claim 1, wherein:

said first line card comprises a second instance of said physical layer circuit; and

- said second instance of said physical layer circuit is operable to switch, in response to detecting a failure of said first instance of said network layer circuit, from processing of a signal received via said first instance of said network layer circuit to processing of a signal received via said interface.
- 5. The system of claim 4, wherein said first instance of said physical layer circuit is operable to, upon detection of a 40 failure of said first instance of said physical layer circuit, communicate with said second instance of said physical layer circuit to effect a failover from said first instance of said physical layer circuit to said second instance of said physical layer circuit.
 - 6. The system of claim 5, wherein:
 - said first instance of said second circuit is coupled to a first power amplifier; and
 - said second instance of said second circuit is coupled to a second power amplifier.
- 7. The system of claim 6, wherein said first instance of said physical layer circuit is operable to detect said failure via monitoring of an output of said first power amplifier.
- **8**. The system of claim **1**, wherein said data bus in an Ethernet data bus.

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9. A method comprising:

in a first line card comprising a first instance of a network layer circuit, a first instance of a physical layer circuit, and an interface to a data bus for communicating with a second line card:

detecting failure of said first instance of said network layer circuit; and in response to detecting said failure of said first instance of said network layer circuit, reconfiguring said first instance of said physical layer circuit to switch from processing a signal received via first instance of said network layer circuit to processing of a signal received via said interface;

wherein said second line card comprises a second instance of said network layer circuit; and

wherein said second instance of said network layer circuit is coupled to said data bus;

wherein said second line card comprises no instances of any physical layer circuit.

10. The system of claim 9, wherein

Said second line card comprises a third instance of said network layer circuit; and

Said third instance of said network layer circuit is coupled to said data bus.

- 11. The system of claim 9, wherein said second line card has a same form factor as said first line card.
- 12. The method of claim 9, wherein said first line card comprises a second instance of said physical layer circuit, and the method comprises:

detecting a failure of said first instance of said network layer circuit; and

- in response to detecting said failure of said first instance of said network layer circuit, reconfiguring said second instance of said physical layer circuit to switch from processing a signal received via said first instance of said network layer circuit to processing a signal received via said interface.
- 13. The system of claim 12, wherein said first instance of said physical layer circuit is operable to, upon detecting a failure of said first instance of said physical layer circuit, communicate with said second instance of said physical layer circuit to effect a failover from said first instance of said physical layer circuit to said second instance of said physical layer circuit.
 - 14. The system of claim 13, wherein:

said first instance of said second circuit is coupled to a first power amplifier; and

said second instance of said second circuit is coupled to a second power amplifier.

- 15. The system of claim 14, wherein said first instance of said physical layer circuit is operable to detect said failure by monitoring an output of said first power amplifier.
- **16**. The system of claim **9**, wherein said data bus in an Ethernet data bus.

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